Switching Transistor

NPN Silicon

Features

• Moisture Sensitivity Level: 1

• ESD Rating: Human Body Model; 4 kV,

Machine Model; 400 V

• These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	40	Vdc
Collector-Base Voltage	V _{CBO}	60	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current - Continuous	Ic	600	mAdc

THERMAL CHARACTERISTICS

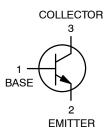
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board T _A = 25°C	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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SC-70 (SOT-323) CASE 419 STYLE 3

MARKING DIAGRAM



(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT4401WT1G	SC-70 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Charac	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS						
Collector-Emitter Breakdown Voltage (Note	V _{(BR)CEO}	40	_	Vdc		
Collector – Base Breakdown Voltage ($I_C = 0$.	V _{(BR)CBO}	60	-	Vdc		
Emitter-Base Breakdown Voltage (I _E = 0.1	V _{(BR)EBO}	6.0	-	Vdc		
Base Cutoff Current (V _{CE} = 35 Vdc, V _{EB} = 0	I _{BEV}	-	0.1	μAdc		
ON CHARACTERISTICS (Note 1)						
$\begin{array}{l} \text{DC Current Gain} \\ \text{(I}_{\text{C}} = 0.1 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 1.0 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 10 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 150 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 500 \text{ mAdc, V}_{\text{CE}} = 2.0 \text{ Vdc)} \end{array}$	h _{FE}	20 40 80 100 40	- - - 300 -	-		
Collector-Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)	V _{CE(sat)}	- -	0.4 0.75	Vdc		
Base – Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)	V _{BE(sat)}	0.75 -	0.95 1.2	Vdc		
Collector Cutoff Current (V _{CE} = 35 Vdc, V _{EB}	I _{CEX}	-	0.1	μAdc		
SMALL-SIGNAL CHARACTERISTICS						
Current-Gain - Bandwidth Product (I _C = 20	mAdc, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	250	-	MHz	
Collector-Base Capacitance (V _{CB} = 5.0 Vd	C _{cb}	-	6.5	pF		
Emitter-Base Capacitance (V _{EB} = 0.5 Vdc,	C _{eb}	-	30	pF		
Input Impedance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ N}$	h _{ie}	1.0	15	kΩ		
Voltage Feedback Ratio ($I_C = 1.0 \text{ mAdc}$, V_{CE}	h _{re}	0.1	8.0	X 10 ⁻⁴		
Small-Signal Current Gain (I _C = 1.0 mAdc,	h _{fe}	40	500	-		
Output Admittance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ mAdc}$	h _{oe}	1.0	30	μmhos		
SWITCHING CHARACTERISTICS						
Delay Time	(V _{CC} = 30 Vdc, V _{EB} = 2.0 Vdc,	t _d	-	15		
Rise Time	I _C = 150 mAdc, I _{B1} = 15 mAdc)	t _r	-	20	ns	
Storage Time	(V _{CC} = 30 Vdc, I _C = 150 mAdc,	t _s	-	225		
Fall Time	I _{B1} = I _{B2} = 15 mAdc)	t _f	-	30	ns	

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

SWITCHING TIME EQUIVALENT TEST CIRCUITS

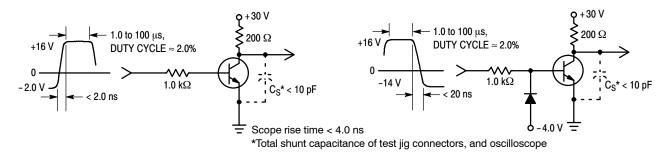
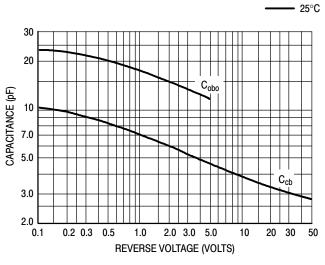


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

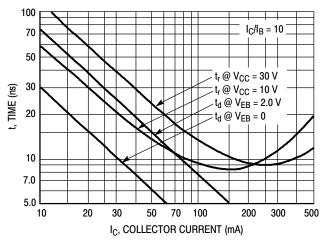
TRANSIENT CHARACTERISTICS



—— 100°C 10 7.0 $V_{CC} = 30 \text{ V}$ 5.0 $I_{\rm C}/I_{\rm B} = 10$ 3.0 2.0 Q, CHARGE (nC) 1.0 0.7 0.5 0.3 0.2 0.1 10 20 70 100 200 300 50 500 IC, COLLECTOR CURRENT (mA)

Figure 3. Capacitances

Figure 4. Charge Data



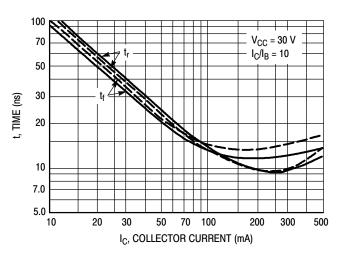
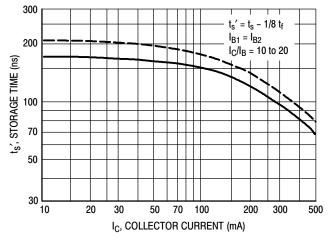


Figure 5. Turn-On Time

Figure 6. Rise and Fall Times



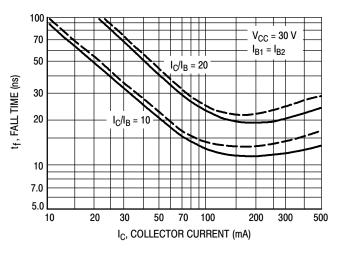


Figure 7. Storage Time

Figure 8. Fall Time

SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE

 $V_{CE} = 10 \text{ Vdc}, T_A = 25^{\circ}\text{C}; Bandwidth = 1.0 \text{ Hz}$

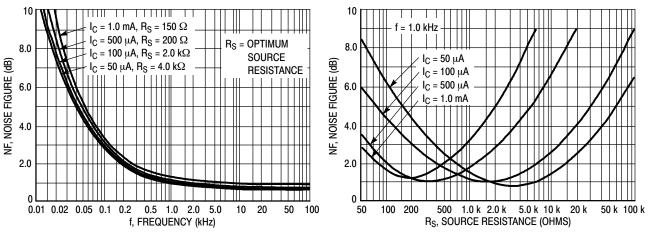


Figure 9. Frequency Effects

Figure 10. Source Resistance Effects

h PARAMETERS

 $V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C}$

This group of graphs illustrates the relationship between h_{fe} and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were selected from the MMBT4401WT1 lines, and the same units were used to develop the correspondingly numbered curves on each graph.

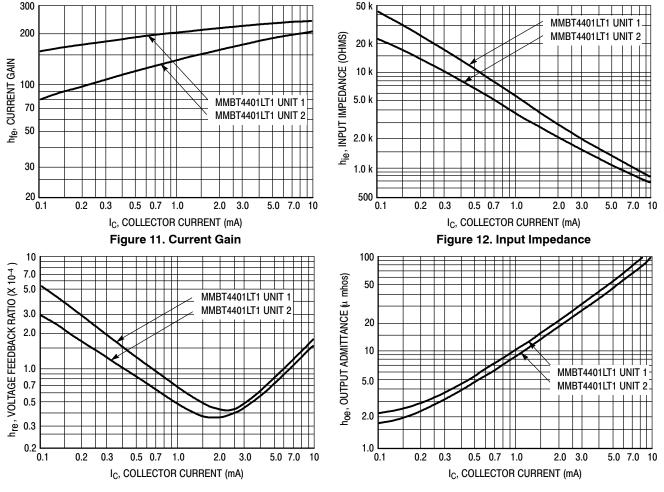
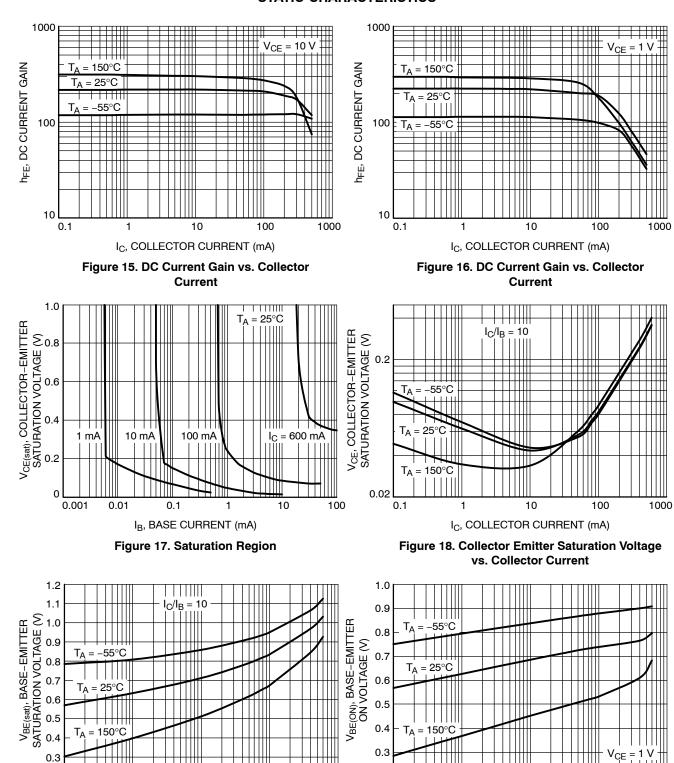


Figure 13. Voltage Feedback Ratio

Figure 14. Output Admittance

STATIC CHARACTERISTICS



I_C, COLLECTOR CURRENT (mA)

Figure 19. Base Emitter Saturation Voltage vs.

Collector Current

10

100

0.2

0.1

I_C, COLLECTOR CURRENT (mA)

Figure 20. Base Emitter Turn-ON Voltage vs.

Collector Current

10

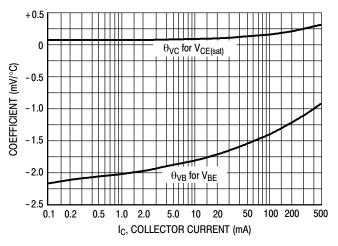
100

1000

1000

0.2

0.1





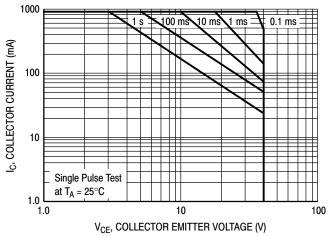
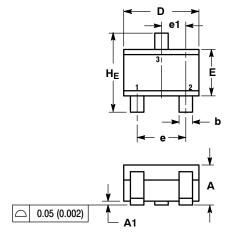


Figure 22. Safe Operating Area

PACKAGE DIMENSIONS

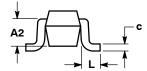
SC-70 (SOT-323) CASE 419-04 ISSUE N



NOTES:

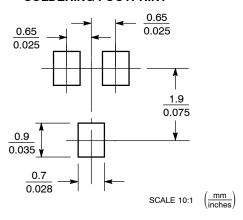
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.032	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2	0.70 REF			0.028 REF			
b	0.30	0.35	0.40	0.012	0.014	0.016	
c	0.10	0.18	0.25	0.004	0.007	0.010	
D	1.80	2.10	2.20	0.071	0.083	0.087	
Е	1.15	1.24	1.35	0.045	0.049	0.053	
е	1.20	1.30	1.40	0.047	0.051	0.055	
e1	0.65 BSC			0.026 BSC			
L	0.20	0.38	0.56	0.008	0.015	0.022	
HE	2.00	2.10	2.40	0.079	0.083	0.095	



STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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